



100V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
	68mΩ @ V _{GS} = 10V	4.6A
100V	86mΩ @ V _{GS} = 6V	4.2A
	116mΩ @ V _{GS} = 4.5V	3.8A

Description

This MOSFET is designed to meet the stringent requirements of automotive applications. The device is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

- · Power-management functions
- DC-DC converters
- Backlighting

Features

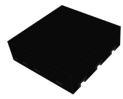
- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production:
 Ensures More Reliable and Robust End Application
- Low R_{DS(ON)} Ensures On-State Losses Are Minimized
- 0.6mm Profile Ideal for Low-Profile Applications
- PCB Footprint of 4mm²
- Sidewall Plated for Improved Optical Inspection
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH10H071LFDFWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

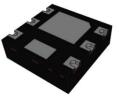
Mechanical Data

- Package: U-DFN2020-6
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe;
 Solderable per MIL-STD-202, Method 208
- Weight: 0.007 grams (Approximate)

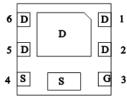
U-DFN2020-6/SWP (Type UXG)



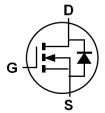




Bottom View



Pin Out Bottom View



Internal Schematic

Ordering Information (Note 4)

Top View

Orderable Part Number	Pankaga	Packing			
Orderable Part Number	Package	Qty.	Carrier		
DMTH10H071LFDFWQ-7	U-DFN2020-6/SWP (Type UXG)	3,000	Reel		
DMTH10H071LFDFWQ-13	U-DFN2020-6/SWP (Type UXG)	10,000	Reel		

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information



77 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 4 = 2024)

W = Week (ex: a = Week 27; z Represents Week 52 and 53)

X = Internal Code (ex: U = Monday)

Date Code Key

Year	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033	2034	2035
Code	4	5	6	7	8	9	0	1	2	3	4	5

Week	1-26	27-52	53
Code	A-Z	a-z	z

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	Т	U	V	W	X	Υ	Z

Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		VDSS	100	V
Gate-Source Voltage	Vgss	±20	V	
Continuous Drain Current (Note 6) V _{GS} = 10V	lo	4.6 3.3	А	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	26	Α
Continuous Source-Drain Diode Current (Note 6)	Is	4.6	Α	
Pulsed Source-Drain Diode Current (10µs Pulse, Duty Cycle:	Ism	26	А	
Avalanche Current, L = 0.1mH	las	22	А	
Avalanche Energy, L = 0.1mH		Eas	24.2	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T _A = +25°C	PD	1.8	W
Thermal Resistance, Junction to Ambient (Note 5)	Reja	81.5	°C/W	
Total Power Dissipation (Note 6)	PD	3	W	
Thermal Resistance, Junction to Ambient (Note 6)	Reja	50	°C/W	
Thermal Resistance, Junction to Case (Note 6)	Tc = +25°C	Rejc	0.7	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

lotes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.



Electrical Characteristics (@ TA = +25°C, unless otherwise specified.)

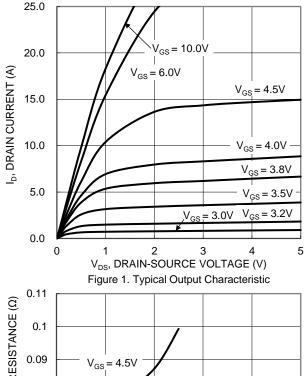
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						•
Drain-Source Breakdown Voltage	BV _{DSS}	100	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 80V, V_{GS} = 0V$
Gate-Source Leakage	Igss	_	_	±100	nA	Vgs = ±20V, Vps = 0V
ON CHARACTERISTICS (Note 7)						•
Gate Threshold Voltage	VGS(TH)	1	_	3	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
		_	48	68		V _G S = 10V, I _D = 4A
Static Drain-Source On-Resistance	RDS(ON)	_	56	86	mΩ	V _G S = 6V, I _D = 4A
		_	70	116		Vgs = 4.5V, ID = 2A
Diode Forward Voltage	VsD	_	0.8	1.0	V	V _G S = 0V, I _S = 1A
DYNAMIC CHARACTERISTICS (Note 8)						•
Input Capacitance	Ciss	_	296	_		
Output Capacitance	Coss	_	83	_	pF	$V_{DS} = 50V, V_{GS} = 0V,$ f = 1MHz
Reverse Transfer Capacitance	Crss	_	12.6	_		I = IIVII IZ
Gate Resistance	Rg	_	11	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	3.4	_		
Total Gate Charge (V _{GS} = 10V)	Qg	_	6.4	_	0	
Gate-Source Charge	Q _{gs}	_	0.8	_	nC	$V_{DS} = 50V, I_{D} = 4.5A$
Gate-Drain Charge	Q _{gd}	_	1.6	_		
Turn-On Delay Time	t _{D(ON)}	_	3	_		
Turn-On Rise Time	t _R	_	19	_		$V_{DS} = 50V$, $R_L = 11\Omega$
Turn-Off Delay Time	tD(OFF)	_	18	_	ns	$V_{GS} = 10V$, $R_{GEN} = 3\Omega$
Turn-Off Fall Time	tF	_	25	_		
Reverse Recovery Time	trr	_	26	_	ns	4.54 11/14 0004/
Reverse Recovery Charge	Qrr	_	54	_	nC	$I_F = 4.5A$, di/dt = 300A/ μ s

Notes:

^{7.} Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.







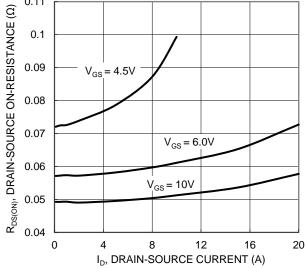


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

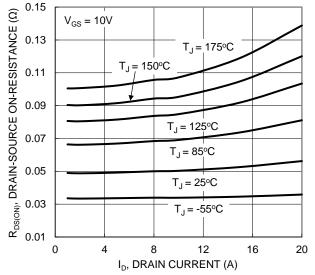
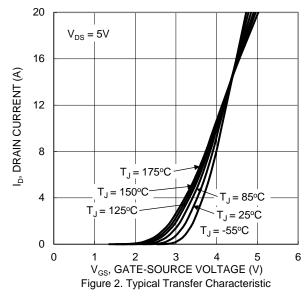


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature



0.11 $R_{DS(ON)},$ DRAIN-SOURCE ON-RESISTANCE (Ω) 0.09 = 4A 0.07 0.05 0.03 0 12 16 20 V_{GS}, GATE-SOURCE VOLTAGE (V) Figure 4. Typical Transfer Characteristic

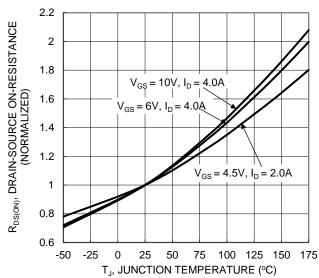


Figure 6. On-Resistance Variation with Junction Temperature





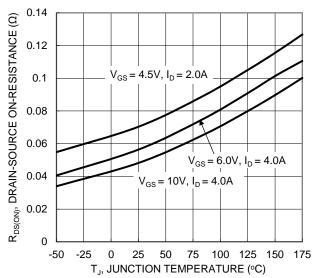
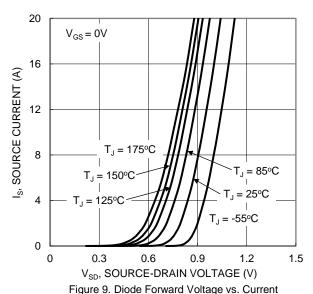


Figure 7. On-Resistance Variation with Junction Temperature



10 9 8 7 6 $V_{GS}(V)$ 4 $V_{DS} = 50V, I_{D} = 4.5A$ 3 2 1 0 2 0 6 8 10 12 $Q_{a}(nC)$ Figure 11. Gate Charge

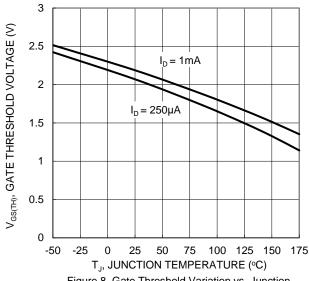
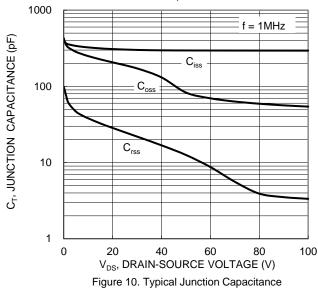


Figure 8. Gate Threshold Variation vs. Junction Temperature



100 R_{DS(ON)} Limited $P_{W} = 100 \mu s$ $P_W = 10ms$ 10 ID, DRAIN CURRENT (A) $P_{W} = 100 ms$ $T_{J(Max)} = 175^{\circ}C$ $T_{A} = 25^{\circ}C$ 0.1 Single Pulse DUT on 1*MRP DC Board $V_{GS} = 10V$ 0.01 0.1 10 1000 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



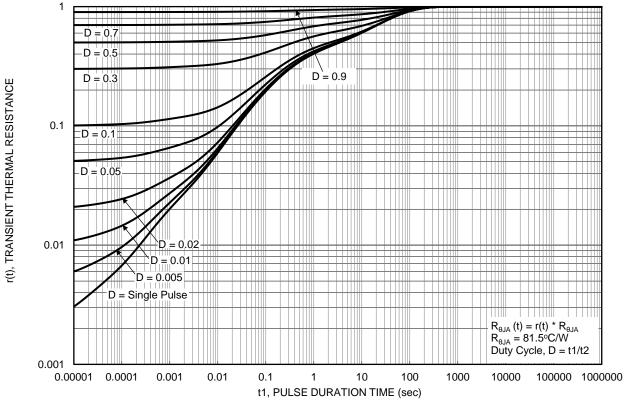


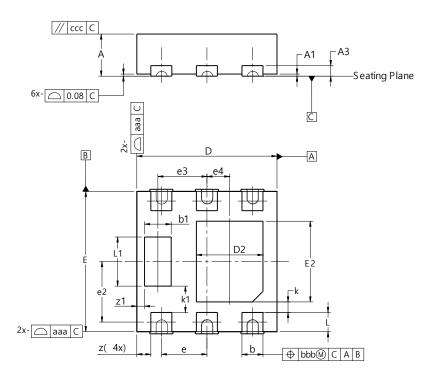
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6/SWP (Type UXG)

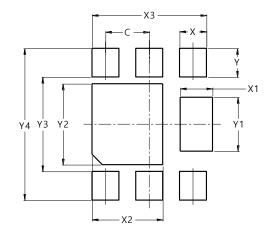


U-DFN2020-6/SWP									
	(Type UXG)								
Dim	Min	Max	Тур						
Α	0.59	0.65	0.62						
A1	0.00	0.05	0.03						
А3			0.152						
b	0.28	0.38	0.33						
b1	0.35	0.45	0.40						
D	1.95	2.05	2.00						
D2	0.87	1.07	0.97						
Е	1.95	2.05	2.00						
E2	1.07	1.17							
е	0.65 BSC								
e3	0.70 BSC								
e4	0	.325 BS	С						
L	0.225	0.325	0.275						
L1	0.67	0.77	0.72						
k			0.15						
k1			0.375						
Z			0.20						
z1	— — 0.1°								
aaa		0.25							
bbb		0.10							
CCC		0.10							
All	Dimens	sions in	mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6/SWP (Type UXG)



Dimensions	Value			
פווטופווסוטווס	(in mm)			
С	0.650			
X	0.350			
X1	0.480			
X2	1.050			
Х3	1.700			
Y	0.425			
Y1	0.800			
Y2	1.200			
Y3	1.400			
Y4	2.250			



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